BYC15-600

Hyperfast power diode

Rev.03 - 24 February 2018 Product data sheet

1. General description

Hyperfast power diode in a SOD59 (2-lead TO-220AC) plastic package.

2. Features and benefits

- Extremely fast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET

3. Applications

- Continuous Current Mode (CCM) Power
- Half-bridge or full-bridge switched-mode
- Half-bridge lighting ballasts

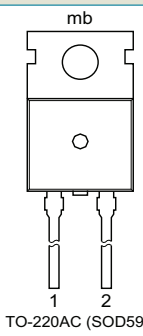
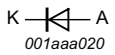
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values				Unit
Absolute maximum rating							
V_{RRM}	repetitive peak reverse voltage		600				V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; $T_{mb} \leq 98$ °C; Fig. 1; Fig. 2	15				A
I_{FRM}	repetitive peak forward current	δ = 0.5 ; t_p = 25 µs; $T_{mb} \leq 98$ °C; square-wave pulse	30				A
I_{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	200				A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	220				A
Symbol	**Parameter**	**Conditions**		**Min**	**Typ**	**Max**	**Unit**
Static characteristics							
V_F	forward voltage	I_F = 15 A; T_j = 150 °C; Fig. 3		-	1.4	2	V
Dynamic characteristics							
t_{rr}	reverse recovery time	I_F = 15 A; V_R = 400 V; dI_F/dt = 500 A/µs; T_j = 25 °C; Fig. 4		-	19	-	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 TO-220AC (SOD59)	 *001aaa020*
2	A	anode		
mb	mb	mounting base; cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BYC15-600	TO-220AC	plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59

7. Marking

Table 4. Marking codes

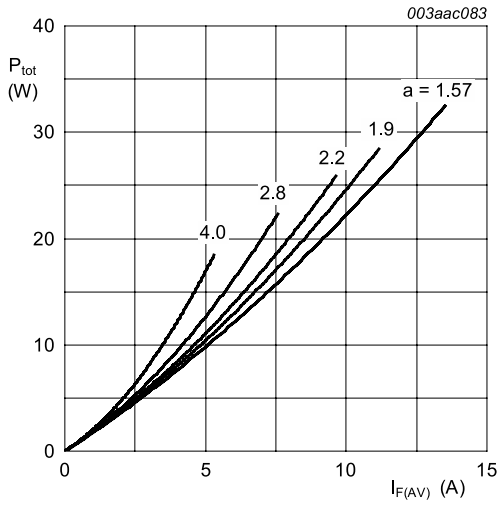
Type number	Marking codes
BYC15-600	BYC15-600

8. Limiting values

Table 5. Limiting values

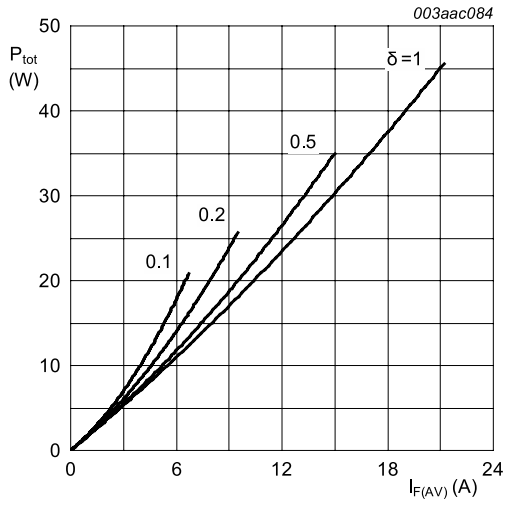
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V_R	reverse voltage	$T_{mb} \leq 100$ °C; DC	500	V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; $T_{mb} \leq 98$ °C; Fig. 1; Fig. 2	15	A
I_{FRM}	repetitive peak forward current	δ = 0.5 ; t_p = 25 µs; $T_{mb} \leq 98$ °C; square-wave pulse	30	A
I_{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	200	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	220	A
T_{stg}	storage temperature		-40 to 150	°C
T_j	junction temperature		150	°C



a = form factor = $I_{F(RMS)} / I_{F(AV)}$

Fig. 1. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values



$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$

Fig. 2. Forward power dissipation as a function of average forward current; square waveform; maximum values

9. Thermal characteristics

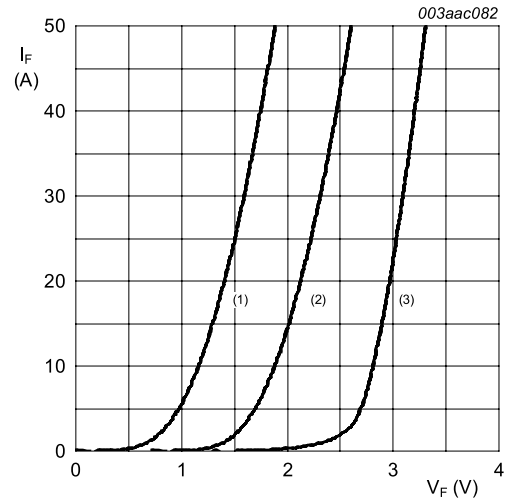
Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	with heatsink compound		-	-	1.5	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	60	-	K/W

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V_F	forward voltage	I_F = 30A; T_j = 150 °C; Fig. 3		-	1.7	2.3	V
		I_F = 15 A; T_j = 25 °C; Fig. 3		-	1.9	2.9	V
		I_F = 15 A; T_j = 150 °C; Fig. 3		-	1.4	2	V
I_R	reverse current	V_R = 600 V; T_j = 25 °C		-	12	200	µA
		V_R = 500 V; T_j = 100 °C		-	1.1	3	mA
Dynamic characteristics							
t_{rr}	reverse recovery time	I_F = 15 A; V_R = 400 V; dI_F/dt = 500 A/µs; T_j = 100 °C; Fig. 4		-	32	40	ns
		I_F = 1 A; V_R = 30 V; dI_F/dt = 50 A/µs; T_j = 25 °C; Fig. 4		-	35	55	ns
		I_F = 15 A; V_R = 400 V; dI_F/dt = 500 A/µs; T_j = 25 °C; Fig. 4		-	19	-	ns
I_{RM}	peak reverse recovery current	I_F = 15 A; V_R = 400 V; dI_F/dt = 500 A/µs; T_j = 125 °C; Fig. 4		-	9.5	12	A
		I_F = 15 A; V_R = 400 V; dI_F/dt = 50 A/µs; T_j = 125 °C; Fig. 4		-	3	7.5	A
v_{FR}	forward recovery voltage	I_F = 15 A; dI_F/dt = 100 A/µs; T_j = 25 °C; Fig. 5		-	8	11	V



(1) T_j = 150 °C; typical values
(2) T_j = 150 °C; maximum values
(3) T_j = 25 °C; maximum values

Fig. 3. Forward current as a function of forward voltage

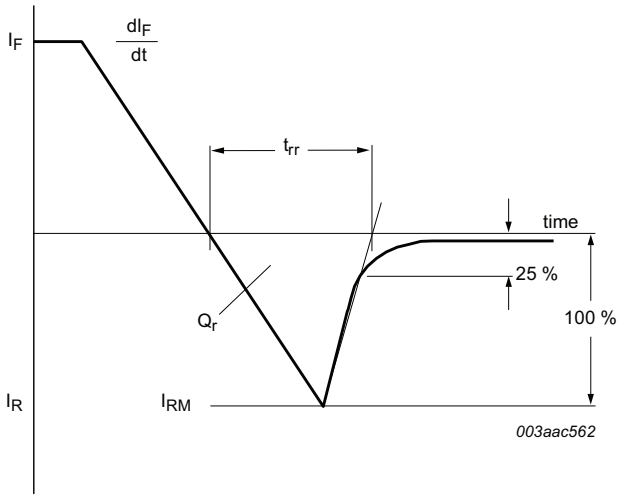


Fig. 4. Reverse recovery definitions; ramp recovery

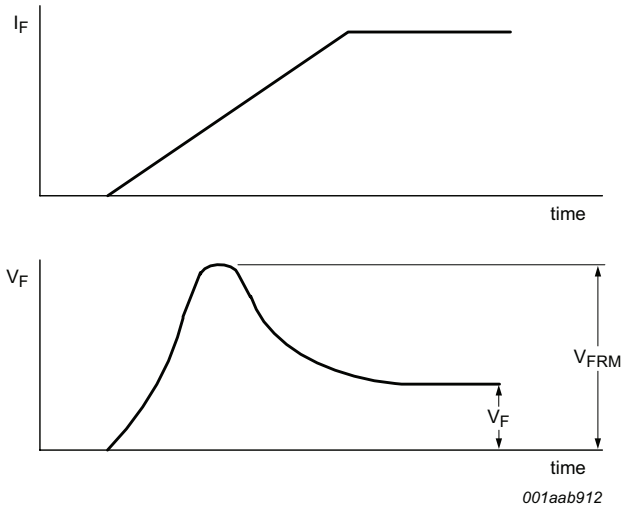
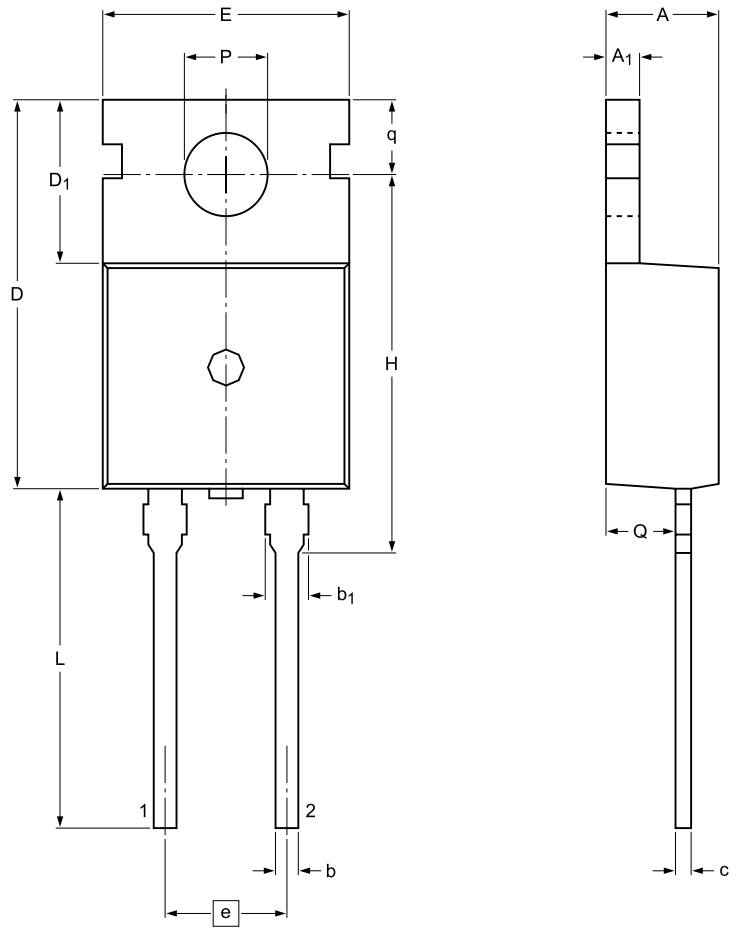


Fig. 5. Forward recovery definitions

11. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC **SOD59**



0 5 10 mm
scale

Dimensions

Unit		A	A_1	b	b_1 (1)	c	D	D_1	E	e	H	L	P	Q	q
mm	max	4.7	1.40	0.95	1.7	0.65	15.8	6.8	10.30	5.08 (REF)	16.25	15.0	3.80	2.6	2.9
	nom														
	min	4.3	1.15	0.70	1.3	0.45	15.6	6.4	9.65		15.70	12.5	3.65	2.2	2.7

Note
1. Protruded dambar are included in the dimension.

sod059_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOD59	2-lead TO-220AC					~~09-08-25~~ 12-11-27

12. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BYC15-600 v.3	20180224	Product data sheet	-	BYC15-600 v.2
Modifications:	Change from NXP version to WeEn version			
BYC15-600 v.2	20100729	Product data sheet	-	BYC15-600 v.1
Modifications:	Various changes to content.			
BYC15-600 v.1	20071129	Product data sheet	-	-

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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